TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3213

MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS **BOARD TESTERS / SCANNERS**

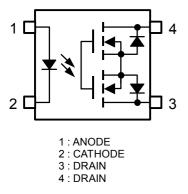
The TOSHIBA TLP3213 is a super small-outline photorelay, suitable for surface-mount assembly. The TLP3213 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

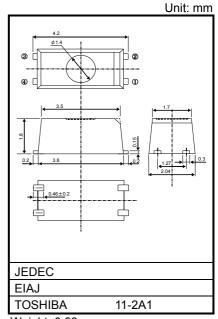
Its characteristics include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

FEATURES

- 4 pin SSOP (1.27SSOP4) : 1.8 mm high, 1.27 mm pitch
- 1-Form-A
- Peak Off-State Voltage : 40 V (MIN.)
- Trigger LED Current : 4 mA (MAX.)
- On-State Current : 80 mA (MAX.)
- On-State Resistance
- Output Capacitance
- $: 35 \Omega$ (MAX.), 25Ω (TYP.) : 1.4 pF (MAX.), 0.6 pF (TYP.)
- Isolation Voltage
- : 1500 Vrms (MIN.)

PIN CONFIGURATION (TOP VIEW)





Weight: 0.03 g

MAXIMUM RATINGS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	١ _F	50	mA
D	Forward Current Derating (Ta \ge 25°C)	∆I _F /°C	-0.5	mA/°C
Ц	Reverse Voltage	V _R	5	V
	Junction Temperature	Tj	125	°C
DETECTOR	Off-State Output Terminal Voltage	V _{OFF}	40	V
	On-State Current	I _{ON}	80	mA
	On-State Current Derating (Ta ≥ 25°C)	∆l _{ON} /°C	-0.8	mA/°C
	Junction Temperature	Tj	125	°C
Storage Temperature Range		T _{stg}	-40~125	°C
Opera	ating Temperature Range	T _{opr}	-20~85	°C
Lead	Soldering Temperature (10 s)	T _{sol}	260	°C
Isolat	ion Voltage (AC, 1 minute, R.H. \leq 60%) (NOTE1)	BVS	1500	Vrms

(NOTE1) : Device considered a two-terminal device : Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

Caution

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

This device is applying super small package which is free for Moisture-Proof packing. However, the application of this device is premised on use under controlled environmental condition like as measuring instrument. It is necessary to take precautions of storage condition and operating environmental condition.

RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V _{DD}	_	_	32	V
Forward Current	١ _F	10	_	30	mA
On-State Current	I _{ON}	_	_	80	mA
Operating Temperature	T _{opr}	25	_	60	°C

INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	$V_R = 5 V$	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	15	_	pF
DETECTOR	Off-State Current	I _{OFF}	V _{OFF} = 30 V, Ta = 50°C	_	_	1000	pА
DETE	Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s	_	0.6	1.4	pF

COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I _{FT}	I _{ON} = 80 mA	_	_	4	mA
Close LED Current	I _{FC}	I _{OFF} = 10 μA	0.2	0.75	_	mA
On-State Resistance	R _{ON}	I _{ON} = 80 mA, I _F = 5 mA, t < 1 s		25	35	Ω

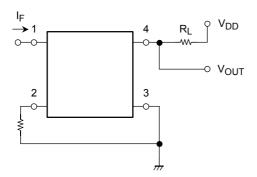
ISOLATION CHARACTERISTICS (Ta = 25°C)

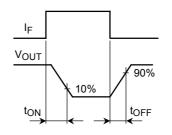
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	CS	$V_{S} = 0 V$, f = 1 MHz	_	0.8	_	pF
Isolation Resistance	R _S	$V_S = 500 \text{ V}, \text{ R.H.} \leq 60\%$	5×10^{10}	10 ¹⁴	_	Ω
	BVS	AC, 1 minute	1500		_	Vrms
Isolation Voltage		AC, 1 second (in oil)	_	3000	_	VIIIS
		DC, 1 minute (in oil)		3000	_	Vdc

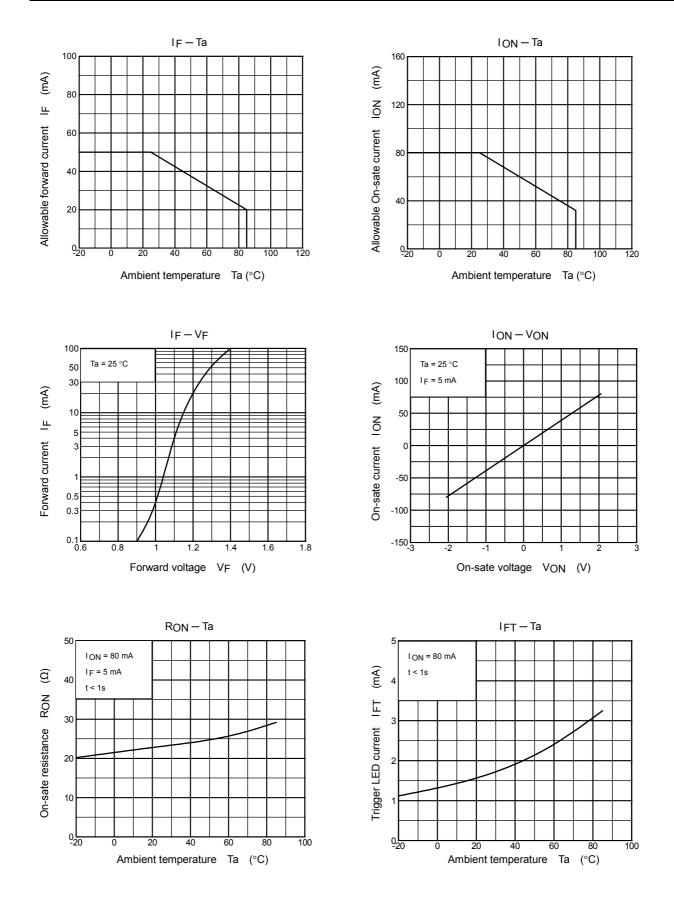
SWITCHING CHARACTERISTICS (Ta = 25°C)

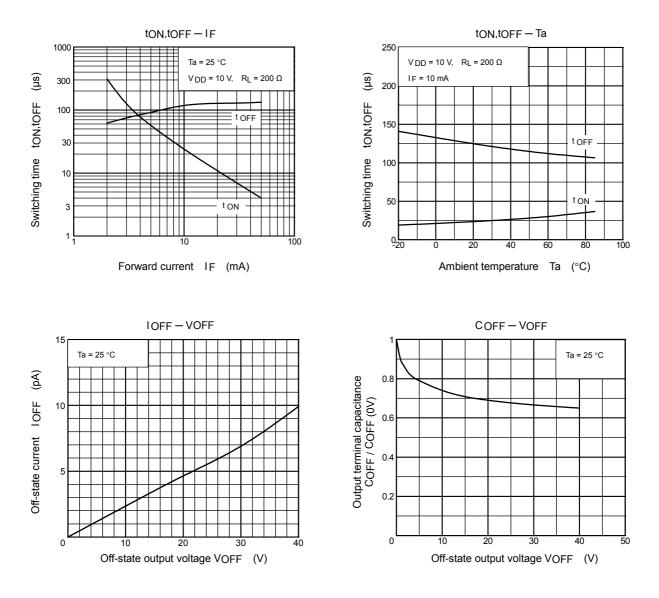
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Turn-on Time	t _{ON}	$R_L = 200 \Omega$ (NO	Έ4) —	—	500	
Turn-off Time	tOFF	$V_{DD} = 10 \text{ V}, \text{ I}_{\text{F}} = 5 \text{ mA}$	_	—	500	μS

(NOTE 4) : SWITCHING TIME TEST CIRCUIT

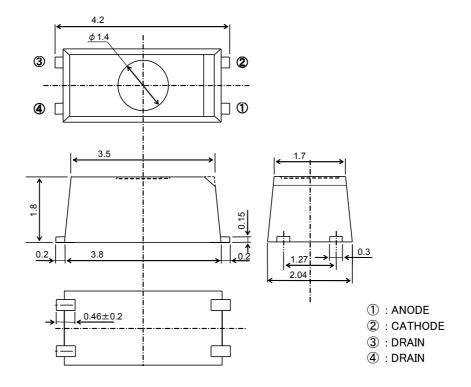








OUTLINE DRAWING



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